

Features

Frequency range: 16MHz to 66MHz

Ceramic SMD package

Seam sealing

External dimensions (mm) L: 2.0 x W: 1.6 x H: 0.5 RoHS compliant & Pb free

Applications

Bluetooth, Wireless LAN Microprocessor Mobile phone, Computer, Modem Audio, Video Consumer products

Electrical Characteristics

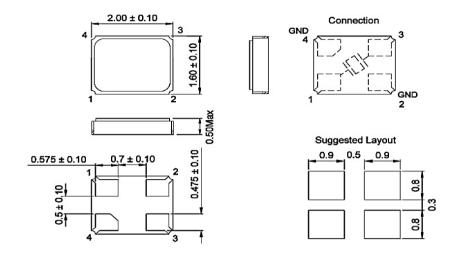
Item		8Y	Conditions
Frequency Range	F_0	16MHz ~ 66MHz	
Frequency Tolerance	F_{tol}	±30ppm, ±20ppm, ±10ppm	at 25°C
Frequency Stability over Operating Temperature Range (refer to 25°C)	F _{stab}	±30 ppm	-20°C ~ +70°C
		±20 ppm	
		±10 ppm	
		±10 ppm	-30°C ~ +85°C
		±30 ppm	40°C ~ +85°C
		±20 ppm	
		±60 ppm	-40°C ~ +125°C
Operating Temperature Range	T _{OTR}	-20°C ~ +70°C	
		-40°C ~ +85°C	
		-40°C ~ +125°C	
Shunt Capacitance	C_0	3pF Max.	
Drive Level	D_L	1 ~ 200μW (50μW Typ.)	
Load Capacitance	C _L	6pF, 8pF, 10pF, 12pF	
Aging	Faging	±3 ppm Max.	at 25°C ± 3°C,first year
Storage Temperature Range	T _{STR}	-55°C ~ +125°C	

Motional Resistance (ESR)

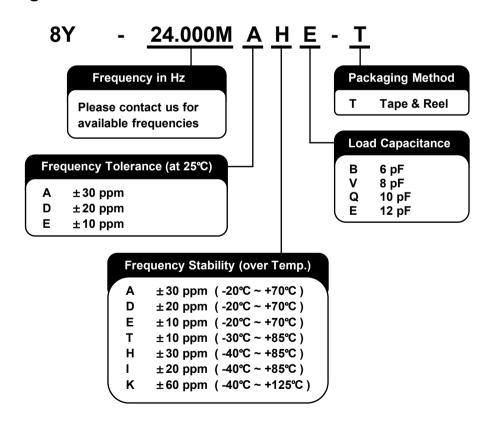
Fundamental				
16 ~ 19.2 MHz	200Ω Max.			
19.2 ~ 30 MHz	100Ω Max.			
30 ~ 66 MHz	80Ω Max.			



Dimensions

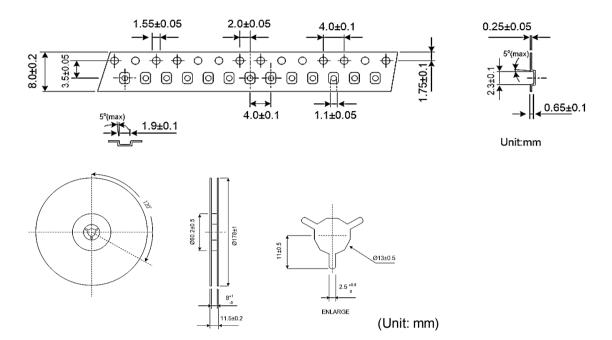


Ordering Information



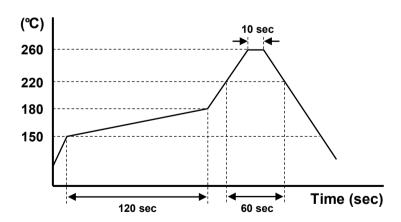


Packing



Reflow Profile

Solder melting point : $220^{\circ}\text{C} \pm 10^{\circ}\text{C}$, 60 sec. Min. Peak temperature : $260^{\circ}\text{C} \pm 10^{\circ}\text{C}$, 10 sec. Min.



Rev. 1.04 Page 3 www.txccrystal.com